

Product Summary

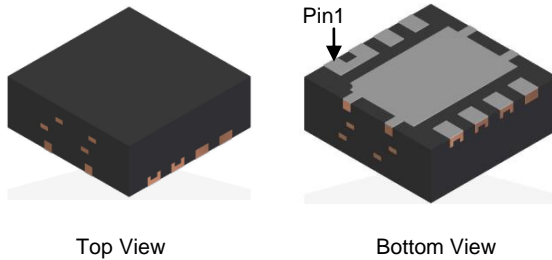
Device	BV _{DSS}	R _{DS(ON)} Max
Q1	30V	14.3mΩ @ V _{GS} = 8V, I _D = 4A
Q2	30V	14.3mΩ @ V _{GS} = 8V, I _D = 4A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Analog Switch

PowerDI3333-8 (Type D)

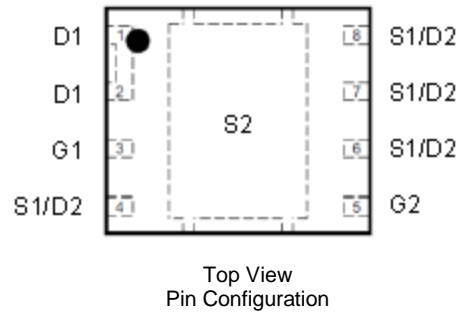


Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **Lead-Free Finish; RoHS Compliant (Note 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: PowerDI[®] 3333-8 (Type D)
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe.
Solderable per MIL-STD-202, Method 208
- Weight: 0.044 grams (Approximate)

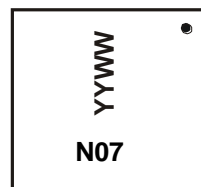


Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3013LFG-7	PowerDI3333-8 (Type D)	1000 / Tape & Reel
DMN3013LFG-13	PowerDI3333-8 (Type D)	3000 / Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



N07 = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 18 = 2018)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1	Q2	Unit
Drain-Source Voltage	V _{DSS}	30		V
Gate-Source Voltage	V _{GSS}	10		V
Continuous Drain Current @ V _{GS} = 5V	T _C = +25°C	15		A
	T _C = +70°C	12		A
Continuous Drain Current @ V _{GS} = 5V	T _A = +25°C	9.5		A
	T _A = +70°C	7.6		A
Continuous Source-Drain Diode Current (Note 5)	I _S	2.7	2.7	A
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)	I _{DM}	80	80	A
Avalanche Current (Note 6) L = 0.1mH	I _{AS}	24	24	A
Avalanche Energy (Note 6) L = 0.1mH	E _{AS}	28	28	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation	P _D	T _A = +25°C	2.16
		T _A = +70°C	1.25
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	Steady State	58.8
		t < 10s	34
Thermal Resistance, Junction to Case	R _{θJC}	6.9	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics Q1 (@T_A = +25°C, unless otherwise specified.)

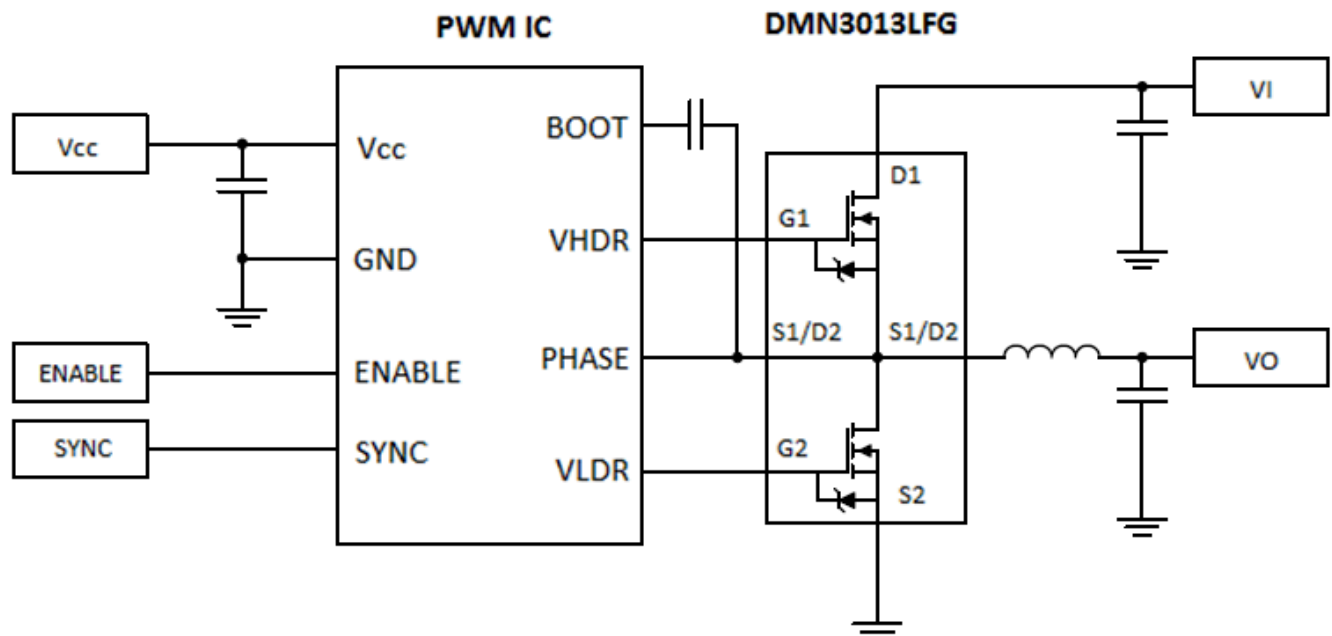
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1	μA	V _{DS} = 20V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	-	-	100	nA	V _{GS} = 10V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.75	0.95	1.2	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	-	10.9	14.3	mΩ	V _{GS} = 8V, I _D = 4A
		-	13.3	16.1	mΩ	V _{GS} = 4.5V, I _D = 4A
		-	15.3	17.7	mΩ	V _{GS} = 3.5V, I _D = 4A
Forward Transfer Admittance	Y _{fs}	-	13	-	S	V _{DS} = 15V, I _D = 4A
Diode Forward Voltage	V _{SD}	-	0.8	1.0	V	V _{GS} = 0V, I _S = 4A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	-	387	600	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	-	219	350		
Reverse Transfer Capacitance	C _{rss}	-	10.4	16		
Gate Resistance	R _g	-	3.3	6.8	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz
Total Gate Charge (V _{GS} = 4.5V)	Q _g	-	3.3	5.7	nC	V _{DS} = 15V, I _D = 4A
Total Gate Charge at V _{TH}	Q _{g(TH)}	-	0.37	-		
Gate-Source Charge	Q _{gs}	-	0.6	-		
Gate-Drain Charge	Q _{gd}	-	0.6	-		
Turn-On Delay Time	t _{D(ON)}	-	4.2	6.3	ns	V _{DD} = 15V, V _{GS} = 4.5V, I _D = 4A, R _g = 2Ω,
Turn-On Rise Time	t _R	-	6.2	-		
Turn-Off Delay Time	t _{D(OFF)}	-	9.7	15		
Turn-Off Fall Time	t _F	-	2.0	-		
Reverse Recovery Time	t _{RR}	-	11.7	-	ns	V _{DS} = 15V, I _F = 4A, di/dt = 300A/μs
Reverse Recovery Charge	Q _{RR}	-	7.5	-	nC	

- Notes:
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 - I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to product testing.

Electrical Characteristics Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	V_{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I_{DSS}	-	-	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}	-	-	100	nA	$V_{GS} = 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	0.75	0.95	1.2	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	10.2	14.3	m Ω	$V_{GS} = 8V, I_D = 4A$
		-	12.7	16.1	m Ω	$V_{GS} = 4.5V, I_D = 4A$
		-	14.8	17.7	m Ω	$V_{GS} = 3.5V, I_D = 4A$
Forward Transfer Admittance	$ Y_{fs} $	-	13	-	s	$V_{DS} = 15V, I_D = 4A$
Diode Forward Voltage	V_{SD}	-	0.8	1.0	V	$V_{GS} = 0V, I_S = 4A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C_{iss}	-	397	600	pF	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1.0MHz$
Output Capacitance	C_{oss}	-	217	350	pF	
Reverse Transfer Capacitance	C_{rss}	-	10.4	16	pF	
Gate Resistance	R_g	-	3.3	6.8	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge ($V_{GS} = 4.5V$)	Q_g	-	3.4	5.7	nC	$V_{DS} = 15V, I_D = 4A$
Total Gate Charge at V_{TH}	$Q_{g(TH)}$	-	0.39	-	nC	
Gate-Source Charge	Q_{gs}	-	0.6	-	nC	
Gate-Drain Charge	Q_{gd}	-	0.6	-	nC	
Turn-On Delay Time	$t_{D(ON)}$	-	4.4	6.3	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_D = 4A, R_g = 2\Omega$
Turn-On Rise Time	t_R	-	6.7	-	ns	
Turn-Off Delay Time	$t_{D(OFF)}$	-	10.4	15	ns	
Turn-Off Fall Time	t_F	-	2.2	-	ns	
Reverse Recovery Time	t_{RR}	-	11.8	-	ns	$V_{DS} = 15V, I_F = 4A, di/dt =$ $300A/\mu s$
Reverse Recovery Charge	Q_{RR}	-	7.8	-	nC	

Notes: 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

Typical Circuit


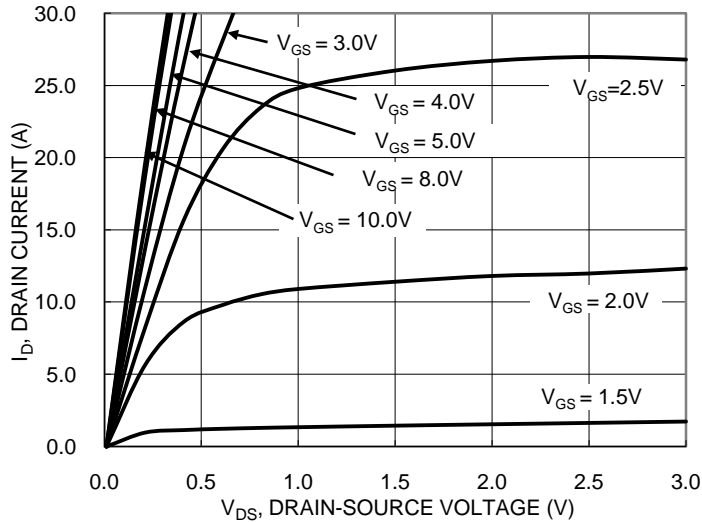


Figure 1. Typical Output Characteristic

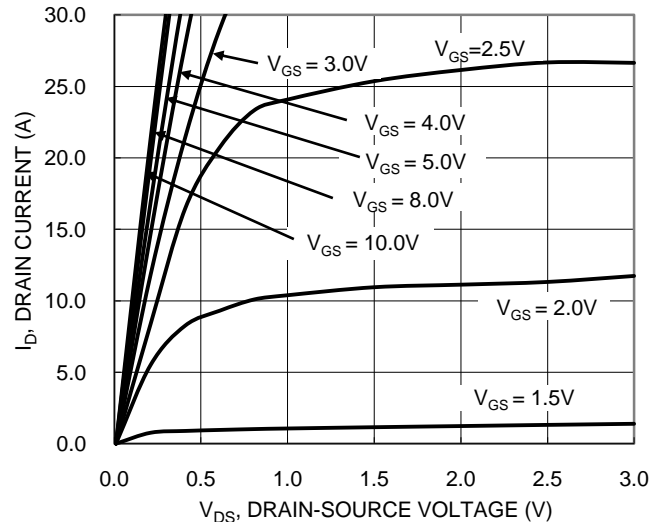


Figure 2. Typical Output Characteristic

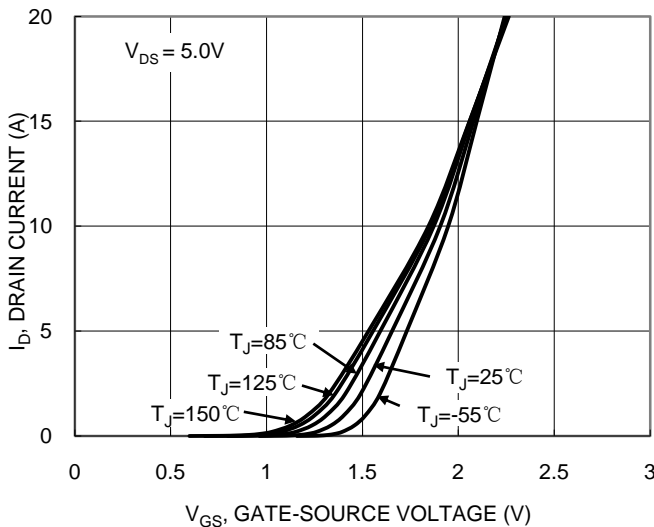


Figure 3. Typical Transfer Characteristic

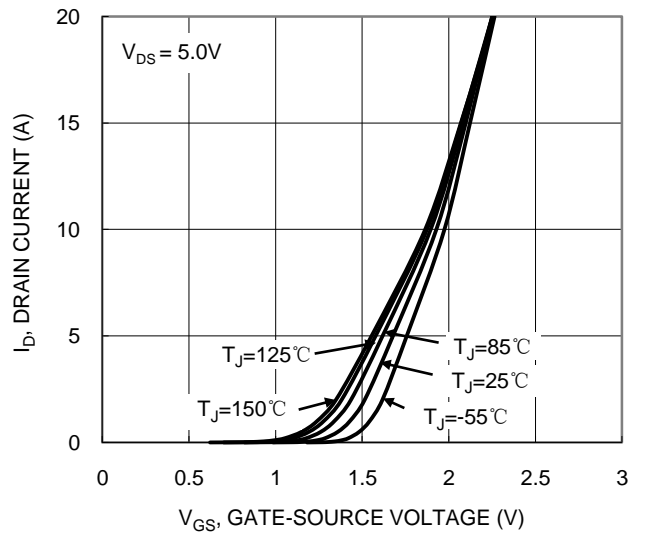


Figure 4. Typical Transfer Characteristic

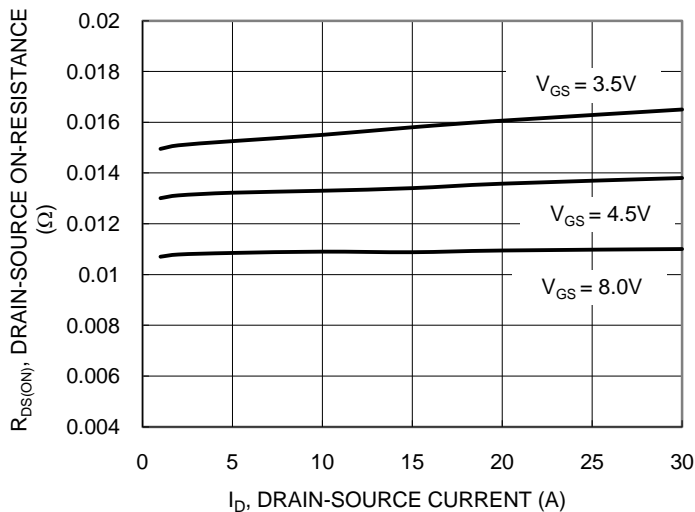


Figure 5. Typical On-Resistance vs. Drain Current and Gate Voltage

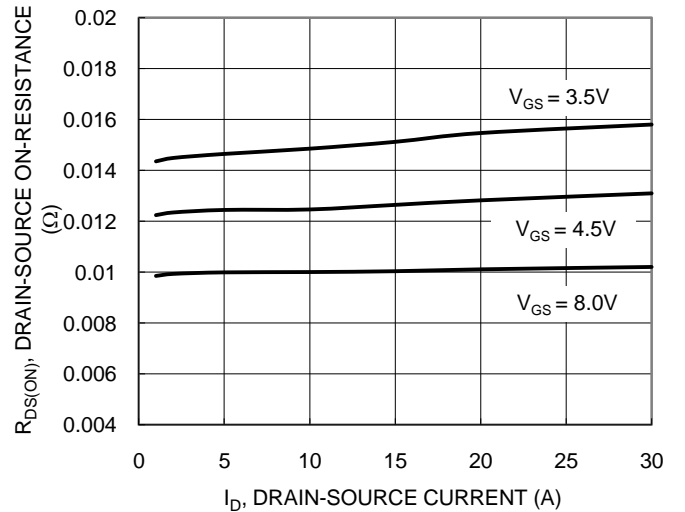


Figure 6. Typical On-Resistance vs. Drain Current and Gate Voltage

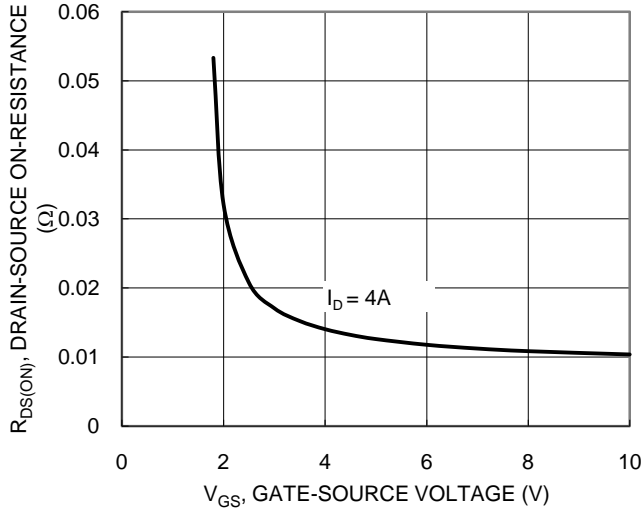


Figure 7. Typical Transfer Characteristic

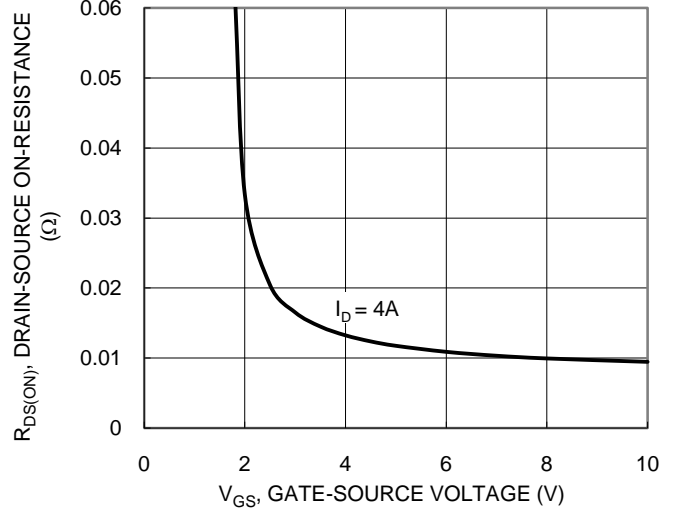


Figure 8. Typical Transfer Characteristic

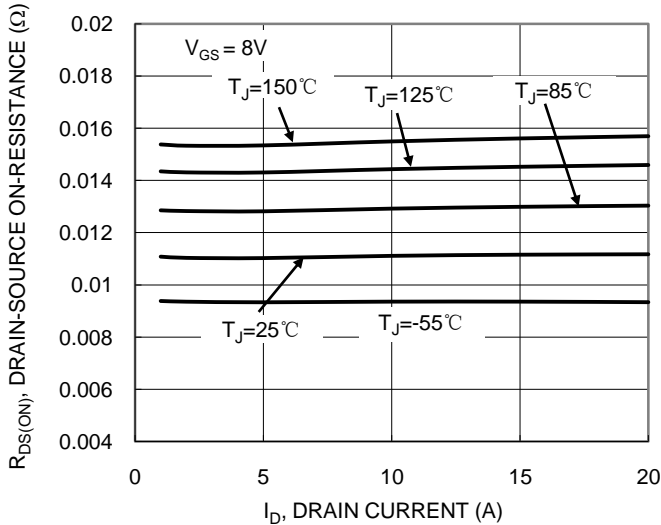


Figure 9. Typical On-Resistance vs. Drain Current and Junction Temperature

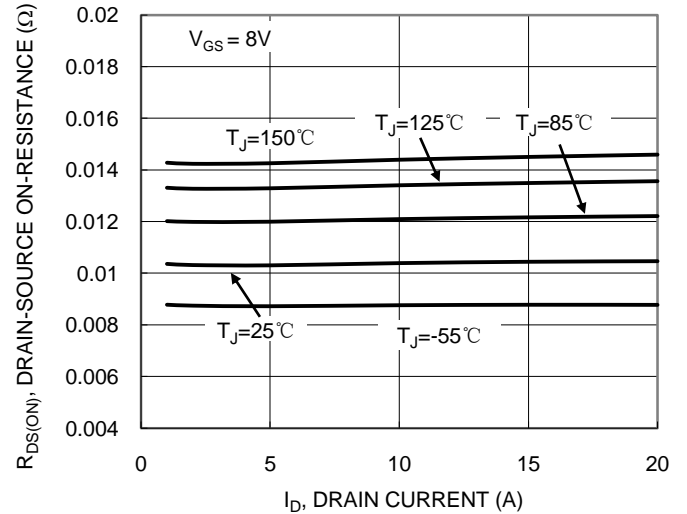


Figure 10. Typical On-Resistance vs. Drain Current and Junction Temperature

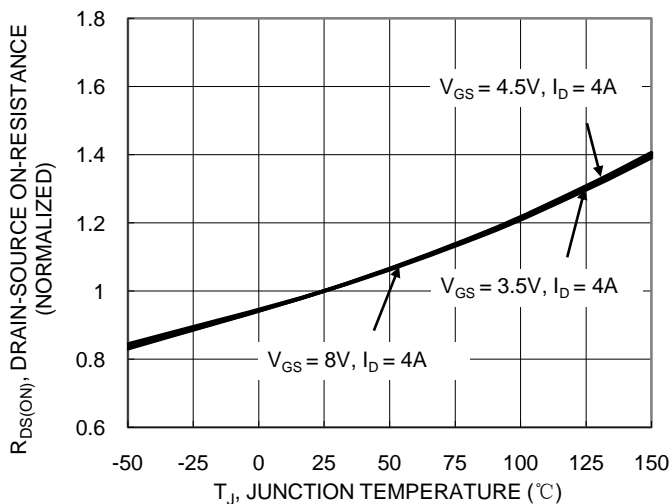


Figure 11. On-Resistance Variation with Junction Temperature

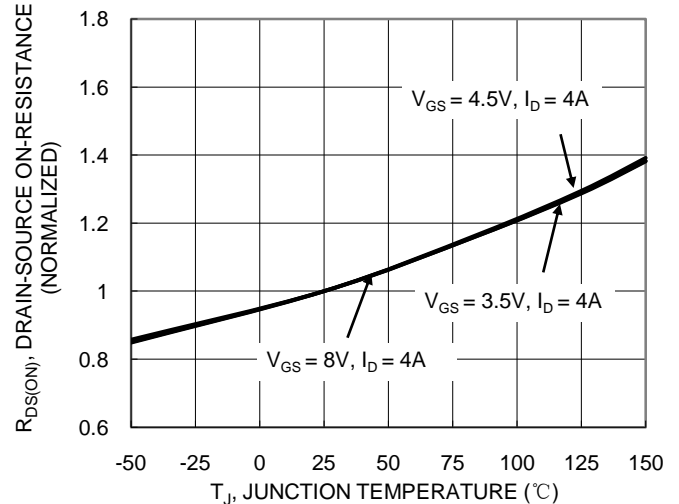
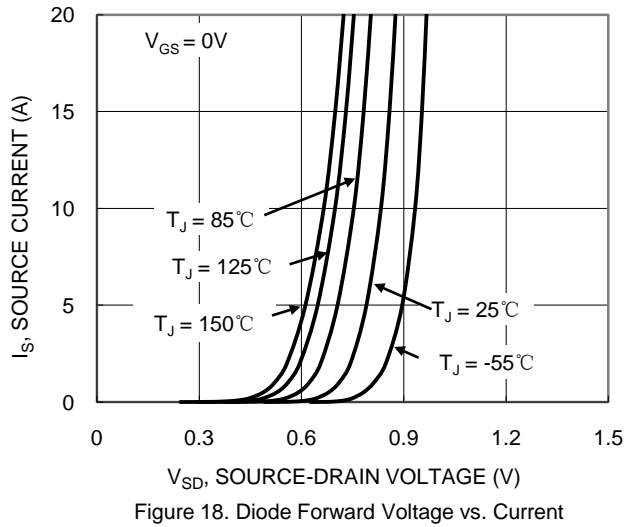
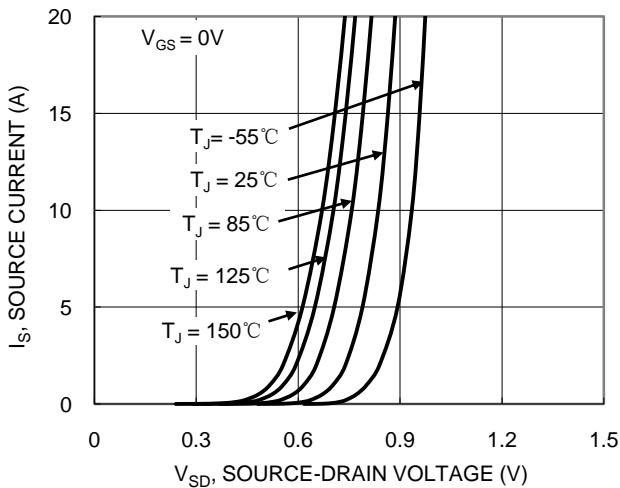
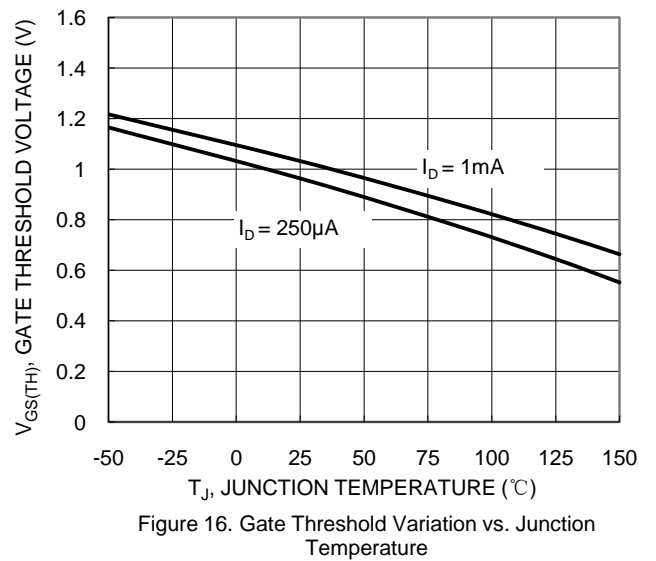
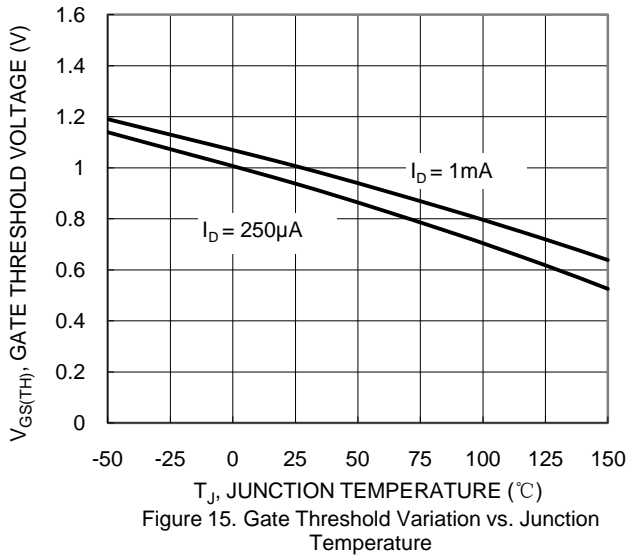
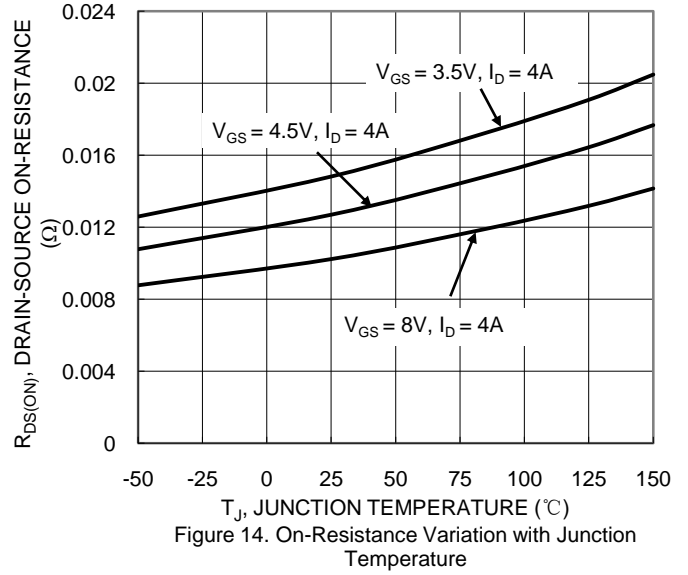
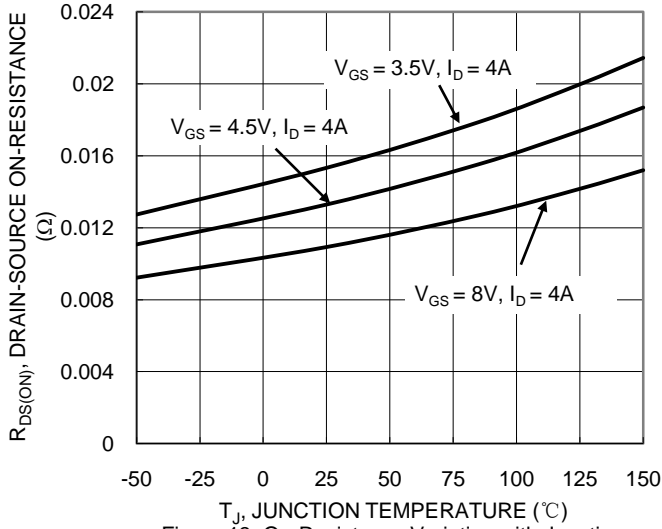


Figure 12. On-Resistance Variation with Junction Temperature



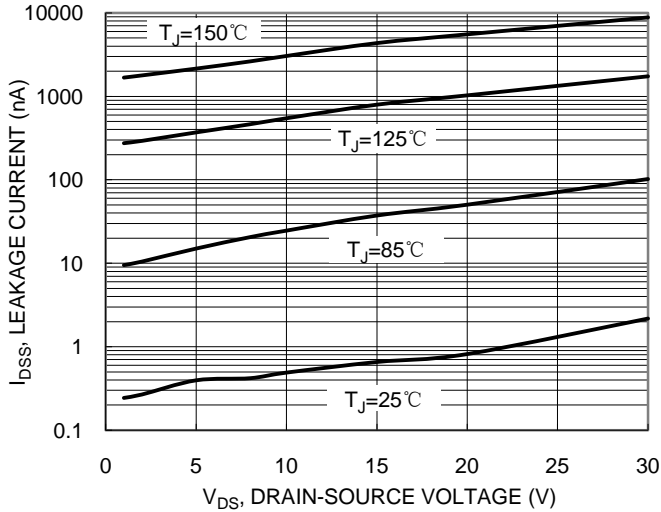


Figure 19. Typical Drain-Source Leakage Current vs. Voltage

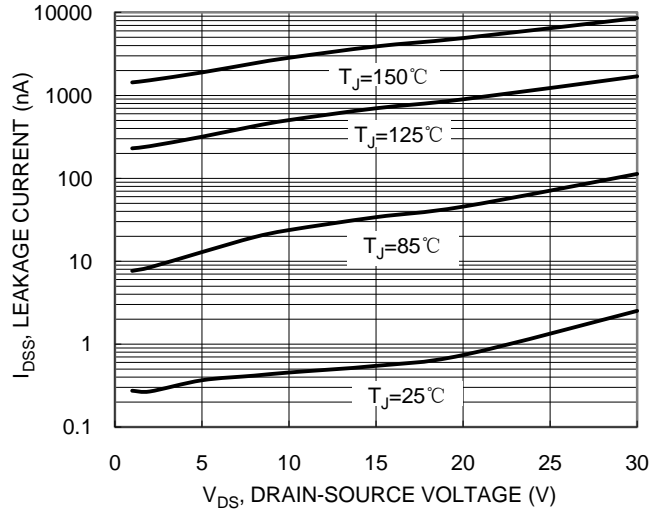


Figure 20. Typical Drain-Source Leakage Current vs. Voltage

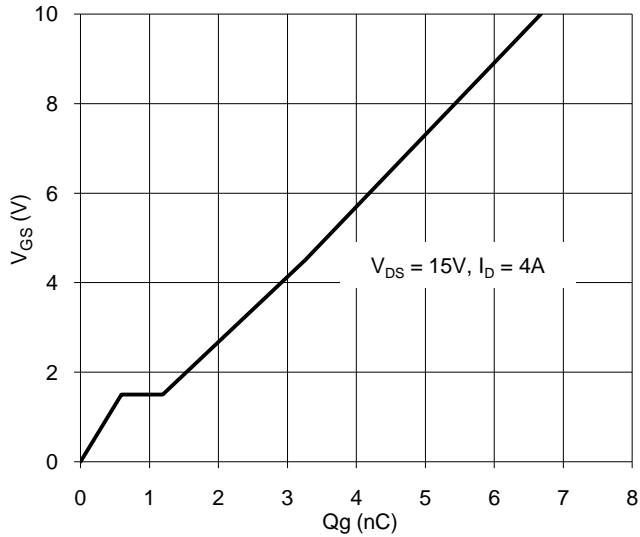


Figure 21. Gate Charge

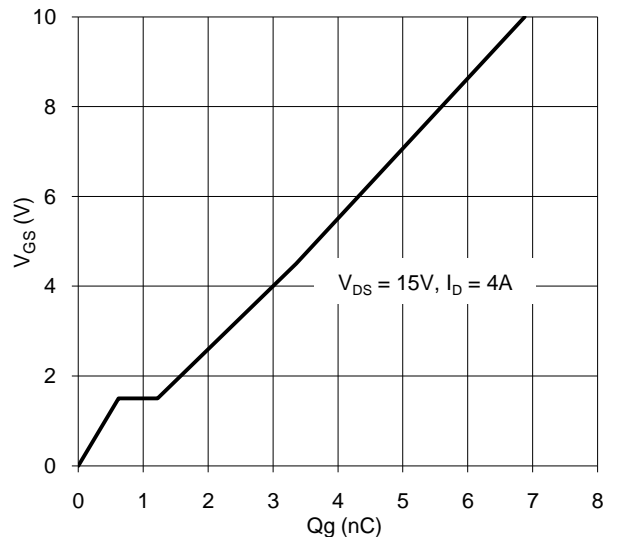


Figure 22. Gate Charge

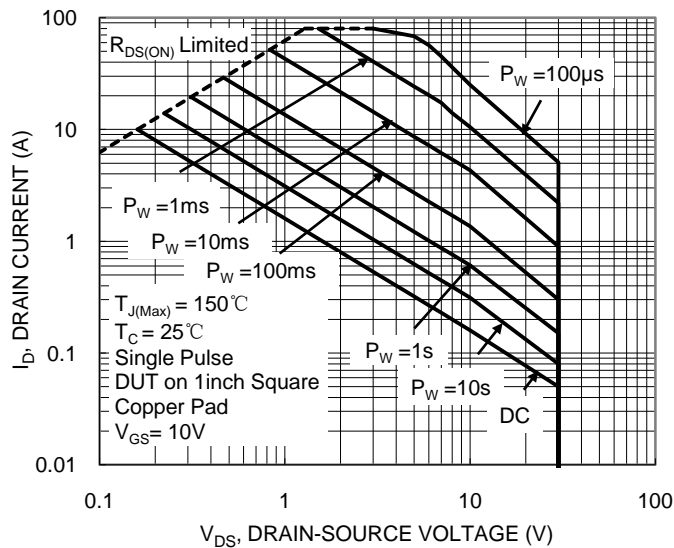


Figure 23. SOA, Safe Operation Area

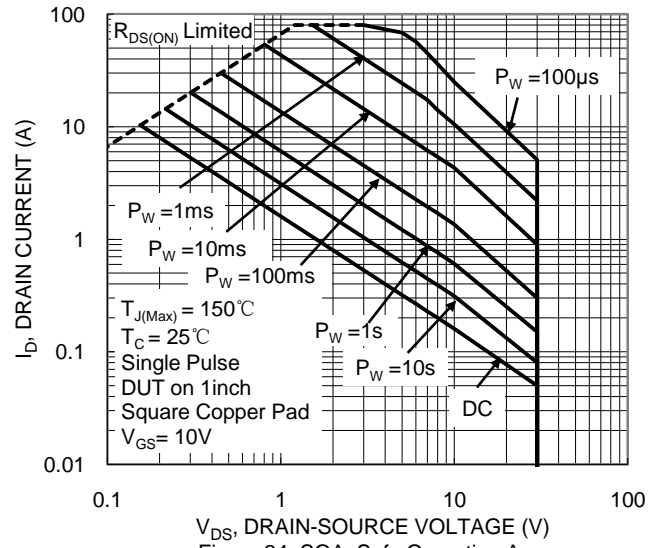


Figure 24. SOA, Safe Operation Area

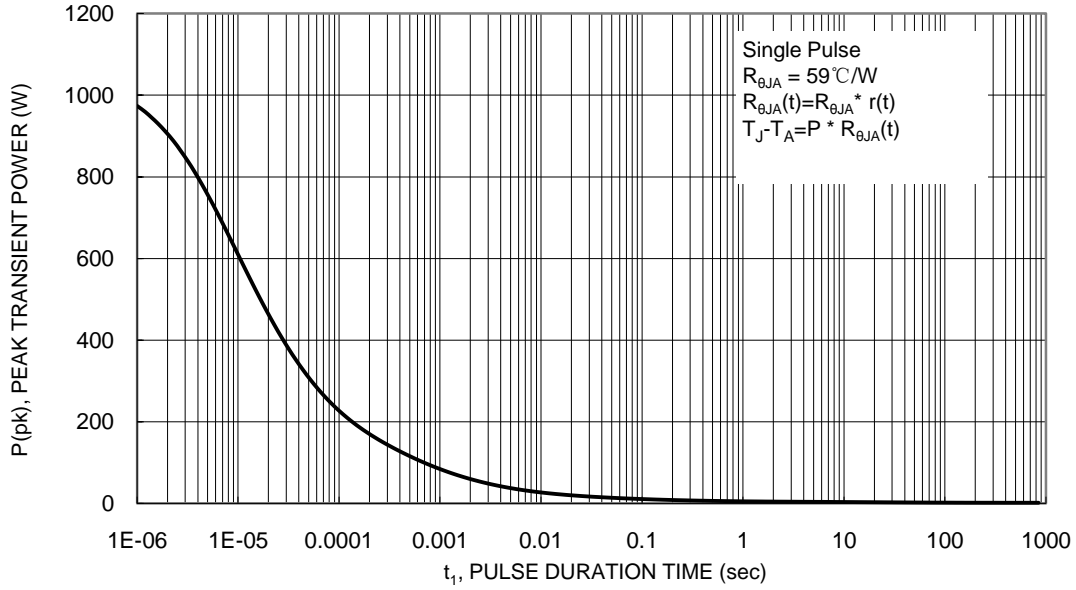


Figure 25. Single Pulse Maximum Power Dissipation

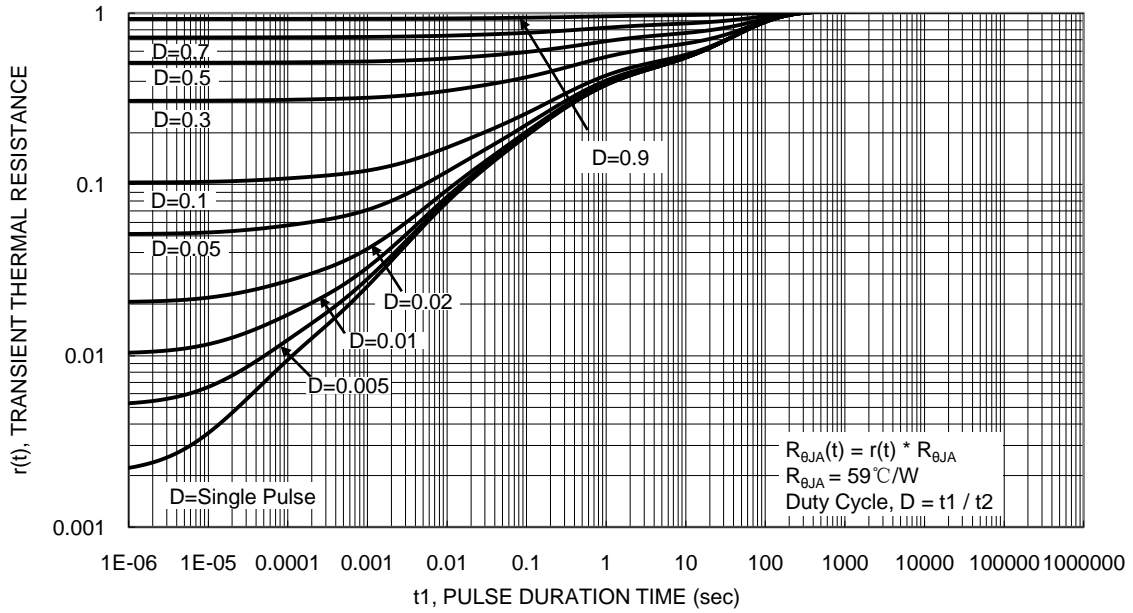
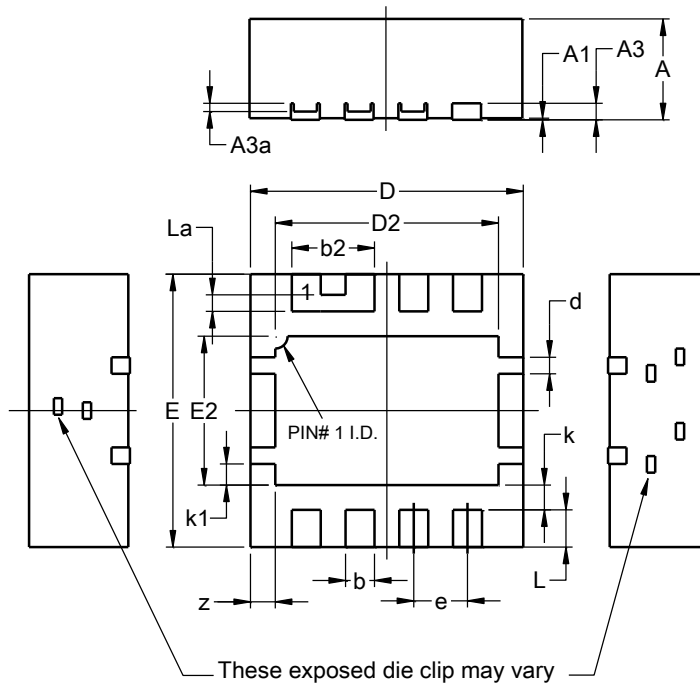


Figure 26. Transient Thermal Resistance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI3333-8 (Type D)

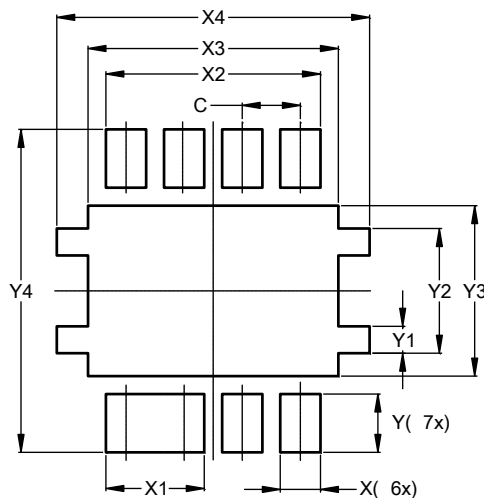


PowerDI3333-8 (Type D)			
Dim	Min	Max	Typ
A	1.17	1.23	1.20
A1	0.00	0.05	0.02
A3	0.15	0.25	0.20
A3a	0.05	0.15	0.10
b	0.30	0.40	0.35
b2	0.95	1.05	1.00
D	3.20	3.40	3.30
D2	2.65	2.75	2.70
E	3.20	3.40	3.30
E2	1.75	1.85	1.80
d	0.15	0.25	0.20
e	--	--	0.65
k	--	--	0.30
k1	0.21	0.31	0.26
L	0.40	0.50	0.45
La	0.15	0.25	0.20
z	0.25	0.35	0.30
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI3333-8 (Type D)



Dimensions	Value (in mm)
C	0.650
X	0.450
X1	1.100
X2	2.400
X3	2.800
X4	3.500
Y	0.650
Y1	0.300
Y2	1.390
Y3	1.900
Y4	3.600

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1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

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- Поставка более 17-ти миллионов наименований электронных компонентов;
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- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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